



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) THIS PACKAGE DOES NOT COMPLY TO ANY CURRENT PACKAGING STANDARD
 - B) ALL DIMENSIONS ARE IN MILLIMETERS
 - C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
 - D) () IS REFERENCE
 - E) [] IS ASSY QUALITY
 - F) DRAWING FILENAME: MOD23DAREV2.0
 - G) FAIRCHILD SEMICONDUCTOR

LAND PATTERN RECOMMENDATIONS